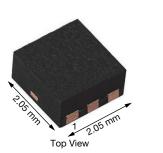
# SiA4265EDJ

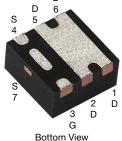
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**Vishay Siliconix** 

# P-Channel 20 V (D-S) MOSFET

#### PowerPAK<sup>®</sup> SC-70-6L Single D





**PRODUCT SUMMARY** -20 V<sub>DS</sub> (V)  $R_{DS(on)}$  max. ( $\Omega$ ) at  $V_{GS} = -4.5$  V 0.0320

#### 0.0410 $R_{DS(on)}$ max. (Ω) at $V_{GS}$ = -2.5 V 0.0675 $R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -1.8 V Q<sub>q</sub> typ. (nC) 13.8 I<sub>D</sub> (A) a, e -9 Configuration Single

# Marking Code: KC

#### **ORDERING INFORMATION** PowerPAK SC-70 Package Lead (Pb)-free and halogen-free SiA4265EDJ-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_A = 25 \text{ °C}$ , unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-20	V	
Gate-source voltage		V <sub>GS</sub>	± 8		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		-9 e	А	
	T <sub>C</sub> = 70 °C	- I <sub>D</sub>	-9 e		
	T <sub>A</sub> = 25 °C		-7.8 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		-6.2 <sup>b, c</sup>		
Pulsed drain current (t = 300 µs)		I <sub>DM</sub>	-20		
Continuous source-drain diode current	T <sub>C</sub> = 25 °C		-9 e	1	
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	-2.4		
	T <sub>C</sub> = 25 °C		15.6		
Maximum power dissipation	T <sub>C</sub> = 70 °C	PD	10	w	
	T <sub>A</sub> = 25 °C		2.9 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		1.8 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering recommendations (peak temperature) d, e			260	C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 5 s	R <sub>thJA</sub>	32	43	°C/W	
Maximum junction-to-foot (drain)	Steady state	R <sub>thJF</sub>	6	8	0/11	

### Notes

a.  $T_C = 25 \ ^{\circ}C$ 

b. Surface mounted on 1" x 1" FR4 board

c. t = 5 s

d. Maximum under steady state conditions is 80 °C/W

e. Package limited

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For technical questions, contact: pmostechsupport@vishay.com



RoHS COMPLIANT HALOGEN

FREE

- Small footprint area - Low on-resistance

• TrenchFET<sup>®</sup> power MOSFET

Typical ESD protection: 3000 V (HBM)

Thermally enhanced PowerPAK<sup>®</sup> SC-70 package

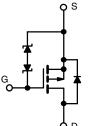
· Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

**FEATURES** 

• 100 % R<sub>g</sub> tested

- · Power management for portable and consumer
  - Load switches
  - Battery switches
  - Charger switches



P-Channel MOSFET

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SiA4265EDJ

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static					•		
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA	-20	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	-14	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μΑ	-	2.5	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.4	-	-1	V	
Gate-source leakage		$V_{DS}$ = 0 V, $V_{GS}$ = ± 8 V	-	-	± 10	μA	
	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 4.5 V$	-	-	± 1		
Zero gate voltage drain current		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	-1		
	IDSS	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	-10		
Drain-source on-state resistance <sup>a</sup>		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -4 \text{ A}$	-	0.0265	0.0320		
	R <sub>DS(on)</sub>	$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -4 \text{ A}$	-	0.0340	0.0410		
		V <sub>GS</sub> = -1.8 V, I <sub>D</sub> = -2 A	-	0.0465	0.0675		
Dynamic <sup>b</sup>	•				•		
Input capacitance	C <sub>iss</sub>		-	1180	-		
Output capacitance	C <sub>oss</sub>	V <sub>S</sub> = 0 V, f = 1 MHz	-	135	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	130	-		
Total gate charge	0	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -8 \text{ V}, \text{ I}_{D} = -4.5 \text{ A}$	-	23.8	36	nC	
	Qg		-	13.8	21		
Gate-source charge	Q <sub>gs</sub>	$V_{DS}$ = -10 V, $V_{GS}$ = -4.5 V, $I_{D}$ = -4.5 A	-	1.9	-		
Gate-drain charge	Q <sub>gd</sub>		-	3	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz	2.2	11	22	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	22	33		
Rise time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, \text{ R}_{\text{L}} = 2.8 \Omega$	-	21	32		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -3.6 \text{ A},  \text{V}_{\text{GEN}} = -4.5 \text{ V},  \text{R}_\text{g} = 1  \Omega$	-	62	93		
Fall time	t <sub>f</sub>		-	14	21		
Turn-on delay time	t <sub>d(on)</sub>		-	9	18	ns	
Rise time	t <sub>r</sub>	$V_{DD}$ = -10 V, R <sub>L</sub> = 2.8 $\Omega$	-	6	12		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -3.6$ A, $V_{GEN} = -8$ V, $R_g = 1 \Omega$	-	65	98		
Fall time	t <sub>f</sub>	-	-	15	23		
Drain-Source Body Diode Characteris	tics				•	•	
Continuous source-drain diode current	IS	T <sub>C</sub> = 25 °C		-	-1.4		
Pulse diode forward current	I <sub>SM</sub>		-	-	-20	— A	
Body diode voltage	V <sub>SD</sub>	$I_{\rm S}$ = -3.6 A, $V_{\rm GS}$ = 0 V	-	-0.8	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	13	20	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>		-	5	10	nC	
Reverse recovery fall time	t <sub>a</sub>	$I_F = -3.6 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 \ ^\circ\text{C}$	-	8	-	ns	
Reverse recovery rise time	t <sub>b</sub>		-	5	-		

Notes

a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$ 

b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

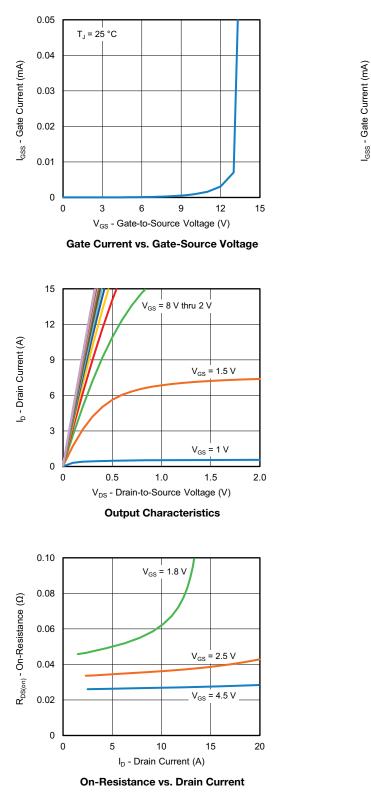
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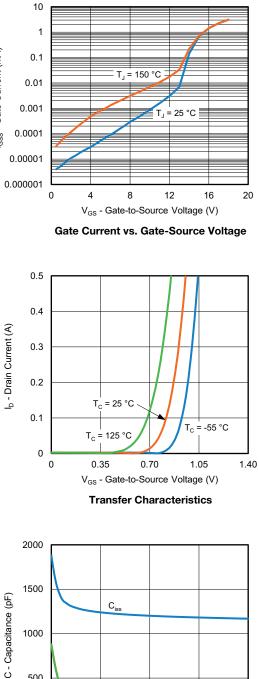


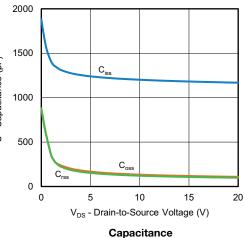
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# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)







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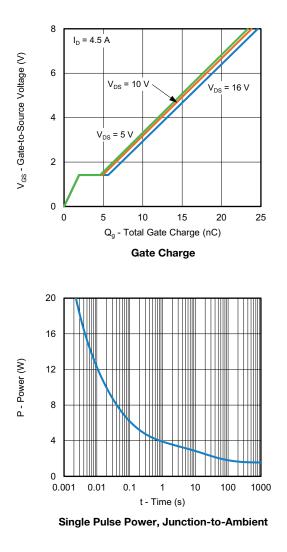
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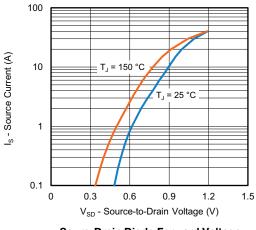
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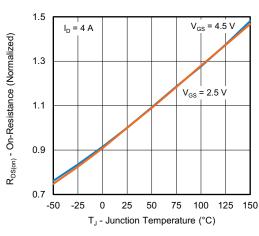
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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

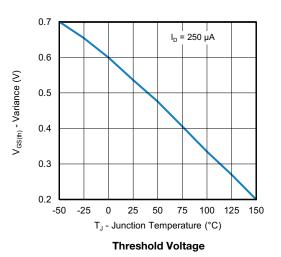


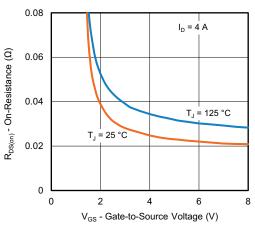


Soure-Drain Diode Forward Voltage



**On-Resistance vs. Junction Temperature** 





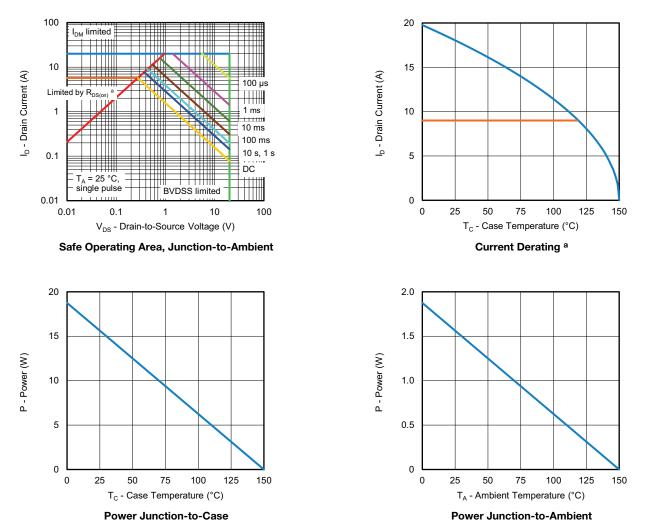
**On-Resistance vs. Gate-to-Source Voltage** 

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



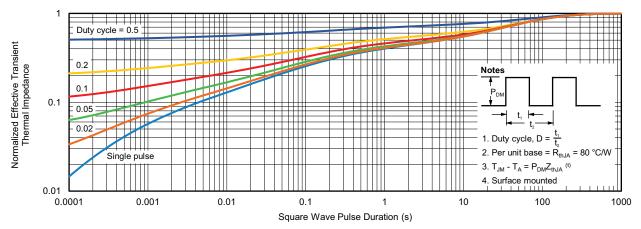
#### Note

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit

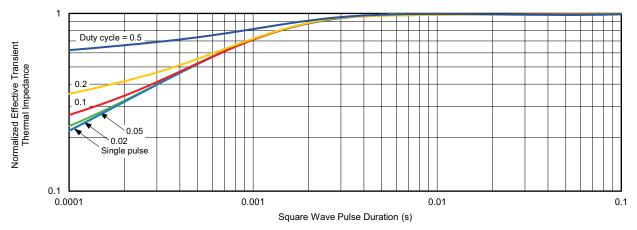


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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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